



## 1N4148WS / BAV16WS

### SURFACE MOUNT FAST SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- Lead Free by Design/RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Notes 2 & 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound (Notes 2 & 3). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.006 grams (approximate)

### **SOD323**



Top View

## Ordering Information (Notes 4 & 5)

Part Number	Qualification	Case	Packaging
1N4148WS-7-F	Commercial	SOD323	3,000/Tape & Reel
1N4148WSQ-7-F	Automotive	SOD323	3,000/Tape & Reel
1N4148WS-13-F	Commercial	SOD323	10,000/Tape & Reel
BAV16WS-7-F	Commercial	SOD323	3,000/Tape & Reel

Notes:

- 1. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead.
- 2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- <1000ppm antimony compounds.</p>
  3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 4. Product manufactured with Date Code OW (week 42, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code OW are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



XX = Product Type Marking Code, T4 or T6



# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage (Note 7)		$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current		I <sub>FM</sub>	300	mA
Average Rectified Output Current		I <sub>0</sub>	150	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

## **Thermal Characteristics**

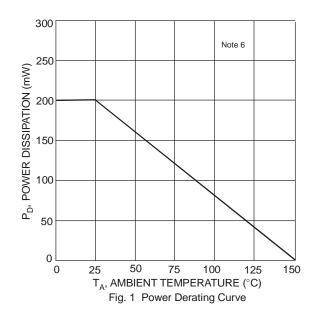
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

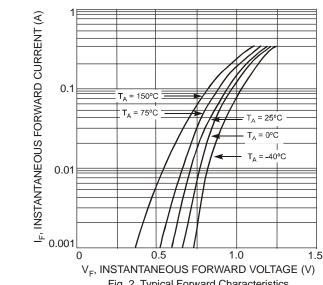
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75	_	>	$I_R = 1.0 \mu A$
Forward Voltage	$V_{FM}$	l	0.715 0.855 1.0 1.25	٧	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Peak Reverse Current (Note 7)	I <sub>RM</sub>		1.0 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$ , $T_J = 150^{\circ}C$ $V_R = 25V$ , $T_J = 150^{\circ}C$ $V_R = 20V$
Total Capacitance	Ст		2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

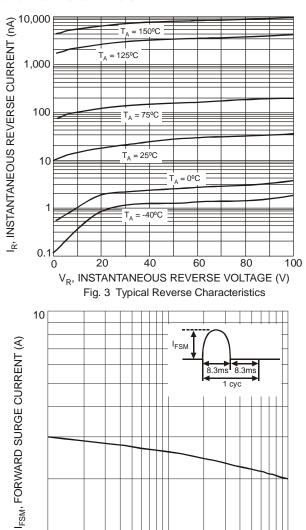
Notes:

- 6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.









NUMBER OF CYCLES
Fig. 5 Maximum Non-Repetitive Surge Current

100

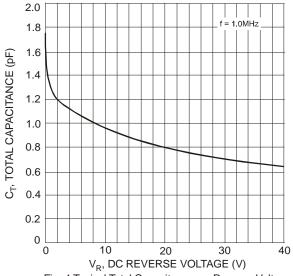
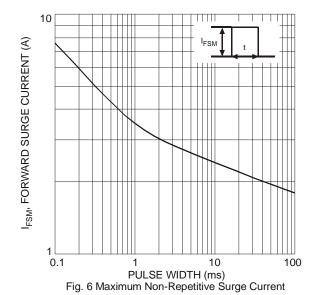
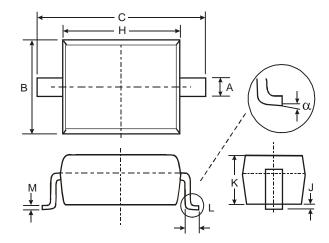


Fig. 4 Typical Total Capacitance vs. Reverse Voltage



**Package Outline Dimensions** 

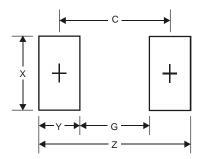
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SOD323			
Dim	Min	Max	
Α	0.25	0.35	
В	1.20	1.40	
C	2.30	2.70	
Η	1.60	1.80	
J	0.00	0.10	
K	1.0	1.1	
L	0.20	0.40	
М	0.10	0.15	
α	0°	8°	
All Dimensions in mm			



## Suggested Pad Layout



Dimensions	Value (in mm)		
Z	3.75		
G	1.05		
Х	0.65		
Υ	1.35		
С	2.40		

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